Abstract

To provide a surface protective film for transpar nt conductive substrates having sufficient transparency and heat resistance, and not demonstrating white turbiness, even when it is placed under a heated environment in a state where the surface protective film is attached on the transparent conductive substrate.

A surface protective film for transparent conductive substrates protecting a surface on a side opposite to a conductive thin film or a surface on a side of the conductive thin film of the transparent conductive substrate, wherein an adhesive layer is formed on one side of a base material film, and an antistatic layer is formed on the other side.